

Advertisers in This Issue

	Page No.
BOMEM	18
Burleigh Instruments	24
Cookson Plasmaterials	45
Digital Instruments	15
Elsevier	81, 86
FEI Company	5
High Voltage Engineering Europa B.V.	inside front cover
Lake Shore Cryotronics	back cover
MDC Vacuum Products	6
Micro Optics	20
MKS Instruments	19
Nano Instruments	16
Park Scientific	8
Philips Electronics	1
Pure Tech	17
Quantum Design	inside back cover
Tencor Instruments	2
VCH Publishers	68
Virginia Semiconductor	20
Voltaix	69

For free information about the products and services offered in this issue, fill out and mail the Reader Service Card, or FAX it to (312) 922-3165.

1992 MRS Fall Meeting

November 30 -
December 4, 1992
Boston, Massachusetts

For information, contact:

Materials Research Society
9800 McKnight Road
Pittsburgh, PA 15237
Phone (412) 367-3003
Fax (412) 367-4373

thin Solid films

International Journal on
the Science and Technology
of Condensed Matter Films



Published in
32 issues per year

Editor-in-Chief:
J.E. Greene

University of Illinois at Urbana
Coordinated Science Laboratory
Urbana, IL, U.S.A.

For:
**Scientists
and
Engineers
active in
research,
development,
and
applications
of
condensed
matter films**

The journal *Thin Solid Films* is in a unique position to both reflect developments in the evolving field of thin films and to provide guidance and coherence.

The field of thin films, which can be defined as the confluence of materials science, surface science, and applied physics, has become an identifiable unified discipline of scientific endeavor. The scope of *Thin Solid Films* is indicated by, but not limited to, the following topical subheadings:

- A. Synthesis and Characterization
- B. Surfaces, Interfaces, and Colloidal Behavior
- C. Metallurgical, Protective, and Hard Layers
- D. Mechanics and Nanomechanics of Thin Layers
- E. Electronics, Optics, and Opto-electronics
- F. Magnetics and Magneto-optics
- G. Superconductivity
- H. Langmuir-Blodgett, Biological, and Related Films
- I. Thin Film Devices, Sensors, and Actuators
- J. Condensed Matter Film Behavior



ELSEVIER
SEQUOIA S.A.

P.O. Box 564
CH-1001 Lausanne 1, Switzerland
Tel.: +41 (21) 20 73 81
Fax: +41(21) 235 444

For customers in the U.S.A.
and Canada:

**Elsevier Science
Publishing Co., Inc.**
Attn.: Journal Information Center
655 Avenue of the Americas
New York, NY 10010, U.S.A.
Tel.: +1 (212) 633-3750
Fax: +1 (212) 633-3764

Please send a free sample copy
and subscription information on
THIN SOLID FILMS



Name: _____
Company/Institute: _____
Street: _____
City: _____
Country: _____
Postal Code: _____
Date: _____ Signature: _____

TSF/mrs 9207

Circle No. 20 on Reader Service Card.